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DATE: 6 December 2016

PCN #: 2254

PCN Title: Addition of New Fab/Assembly Site and Design Change

Dear Customer:

This is an announcement of change(s) to products that are currently being offered by Diodes Incorporated.

We request that you acknowledge receipt of this notification within 30 days of the date of this PCN. If you require samples for evaluation purposes, please make a request within 30 days as well. Otherwise, samples may not be built prior to this change. Please refer to the implementation date of this change as it is stated in the attached PCN form. Please contact your local Diodes sales representative to acknowledge receipt of this PCN and for any sample requests.

The changes announced in this PCN will not be implemented earlier than 90 days from the notification date stated in the attached PCN form.

Previously agreed upon customer specific change process requirements or device specific requirements will be addressed separately.

For questions or clarification regarding this PCN, please contact your local Diodes sales representative.

Sincerely,

Diodes Incorporated PCN Team



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**PRODUCT CHANGE NOTICE****PCN-2254 REV 00**

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Notification Date:	Implementation Date:	Product Family:	Change Type:	PCN #:
6 December, 2016	6 March, 2017	Analog	Assembly Site and Design	<b>2254</b>
<b>TITLE</b>				
Addition of New Fab/Assembly Site and Design Change				
<b>DESCRIPTION OF CHANGE</b>				
This PCN is being issued to notify customers that in order to assure continuity of supply for select parts, Diodes has qualified additional Assembly and Test sites, Tianshui Huatian Technology Co (TSHT) and JCET ChuZhou, and for other select parts Diodes has qualified an additional wafer fab, Shanghai SIM-BCD Semiconductor Manufacturing Co., Ltd (SFAB2).				
Full electrical characterization and high reliability testing has been completed on representative part numbers.				
Please contact your local Diodes representatives for any questions or additional information.				
<b>IMPACT</b>				
Table 1: Add additional assembly and test site TSHT and Metal Change for pop noise optimization Table 2: Add additional assembly and test site JCET ChuZhou Table 3: Add additional wafer fab site SFAB2				
<b>PRODUCTS AFFECTED</b>				
See Tables 1 - 3 below.				
<b>WEB LINKS</b>				
<b>Manufacturer's Notice:</b>	<a href="http://www.diodes.com/pcns">http://www.diodes.com/pcns</a>			
<b>For More Information Contact:</b>	<a href="http://www.diodes.com/contacts.html">http://www.diodes.com/contacts.html</a>			
<b>Data Sheet:</b>	<a href="http://www.diodes.com/catalog">http://www.diodes.com/catalog</a>			
<b>DISCLAIMER</b>				
<b>Unless a Diodes Incorporated Sales representative is contacted in writing within 30 days of the posting of this notice, all changes described in this announcement are considered approved.</b>				

**Table 1: Add assembly and test site, TSHT, and Metal Change for pop noise optimization**

PAM8124RHR					
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**Table 2: Add additional assembly and test site JCET ChuZhou**

PAM2861CBR					
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**Table 3: Add an Additional Fab Site, SFAB2.**

AP3513EMPTR-G1	AP3512EMPTR-G1	AP3512EMTR-G1			
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